

### -20V P-Channel Enhancement Mode MOSFET

#### Description

The AP2305MI uses advanced trench technology

to provide excellent  $R_{\text{DS}(\text{ON})},$  low gate charge and

operation with gate voltages as low as 4.5V. This

device is suitable for use as a

Battery protection or in other Switching application.

#### **General Features**

V<sub>DS</sub> = -20V I<sub>D</sub> =-4.9A

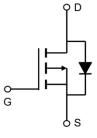
 $R_{DS(ON)} < 38m\Omega @ V_{GS} = -4.5V$ 

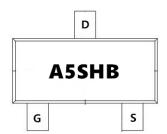
#### Application

Battery protection

Load switch

Uninterruptible power supply







### Package Marking and Ordering Information

Product ID	Pack	Marking	Qty(PCS)
AP2305MI	SOT-23-3L	A5SHB.	3000

#### Absolute Maximum Ratings (Tc=25°C unless otherwise noted)

Symbol	Parameter	Rating	Units
VDS	Drain-Source Voltage	-20	V
V <sub>GS</sub>	Gate-Source Voltage	±12	V
I₀@T <sub>A</sub> =25℃	Continuous Drain Current, V <sub>GS</sub> @ -4.5V <sup>1</sup>	-4.9	А
I <sub>D</sub> @T <sub>A</sub> =70℃	Continuous Drain Current, V <sub>GS</sub> @ -4.5V <sup>1</sup>	-3.9	А
Ідм	Pulsed Drain Current <sup>2</sup>	-14	А
P₀@T <sub>A</sub> =25℃	Total Power Dissipation <sup>3</sup>	1.31	W
P₀@T <sub>A</sub> =70°C	Total Power Dissipation <sup>3</sup>	0.84	W
Тѕтс	Storage Temperature Range	-55 to 150	°C
TJ	Operating Junction Temperature Range	-55 to 150	°C
R₀JA	Thermal Resistance Junction-Ambient <sup>1</sup>	120	°C/W
R₀JA	Thermal Resistance Junction-Ambient <sup>1</sup> (t ≤10s)	95	°C/W

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Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV <sub>DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V , I <sub>D</sub> =-250uA	-20			V
$\triangle BVDSS/ \triangle TJ$	BV <sub>DSS</sub> Temperature Coefficient	Reference to $25^\circ C$ , I <sub>D</sub> =-1mA		-0.014		V/℃
		V <sub>GS</sub> =-4.5V , I <sub>D</sub> =-4.9A		32	38	mΩ
R <sub>DS(ON)</sub>	Static Drain-Source On-Resistance <sup>2</sup>	$V_{GS}$ =-2.5V , I <sub>D</sub> =-3.4A		45	55	
		V <sub>GS</sub> =-1.8V , I <sub>D</sub> =-2A		65	85	
V <sub>GS(th)</sub>	Gate Threshold Voltage	V <sub>GS</sub> =V <sub>DS</sub> , I <sub>D</sub> =-250uA	-0.4		-1.0	V
$ riangle V_{GS(th)}$	$V_{GS(th)}$ Temperature Coefficient	VGS-VDS, ID2500A		3.95		mV/℃
la a a	Drain-Source Leakage Current	$V_{\text{DS}}\text{=-16V}$ , $V_{\text{GS}}\text{=}0\text{V}$ , $T_{\text{J}}\text{=}25^\circ\!\mathbb{C}$			-1	uA
I <sub>DSS</sub>		V <sub>DS</sub> =-16V , V <sub>GS</sub> =0V , T <sub>J</sub> =55℃			-5	
Igss	Gate-Source Leakage Current	$V_{GS}$ =±12V , $V_{DS}$ =0V			±100	nA
gfs	Forward Transconductance	V <sub>DS</sub> =-5V , I <sub>D</sub> =-3A		12.8		S
Qg	Total Gate Charge (-4.5V)			10.2	14.3	
Qgs	Gate-Source Charge	V <sub>DS</sub> =-15V , V <sub>GS</sub> =-4.5V , I <sub>D</sub> =-3A		1.89	2.6	nC
Q <sub>gd</sub>	Gate-Drain Charge			3.1	4.3	
T <sub>d(on)</sub>	Turn-On Delay Time			5.6	11.2	
Tr	Rise Time	V <sub>DD</sub> =-10V , V <sub>GS</sub> =-4.5V ,		40.8	73	
T <sub>d(off)</sub>	Turn-Off Delay Time	R <sub>G</sub> =3.3 , I <sub>D</sub> =-3A		33.6	67	ns
T <sub>f</sub>	Fall Time			18	36	
Ciss	Input Capacitance			857	1200	
Coss	Output Capacitance	V <sub>DS</sub> =-15V , V <sub>GS</sub> =0V , f=1MHz		114	160	_
Crss	Reverse Transfer Capacitance			108	151	pF
ls	Continuous Source Current <sup>1,4</sup>				-4.9	А
lsм	Pulsed Source Current <sup>2,4</sup>	$V_G=V_D=0V$ , Force Current			-14	А
Vsd	Diode Forward Voltage <sup>2</sup>	V <sub>GS</sub> =0V , I <sub>S</sub> =-1A , TJ=25℃			-1	V
t <sub>rr</sub>	Reverse Recovery Time	IF=-3A , di/dt=100A/µs ,		21.8		nS
Qrr	Reverse Recovery Charge	T <b>J=25</b> ℃		6.9		nC

#### Electrical Characteristics (TJ=25°C, unless otherwise noted)

Note :

1. The data tested by surface mounted on a 1 inch<sup>2</sup> FR-4 board with 2OZ copper.

2、The data tested by pulsed , pulse width  $\bigtriangleup$  300us , duty cycle  $\bigtriangleup$  2%

3. The power dissipation is limited by 150  $^\circ\!\mathrm{C}$  junction temperature

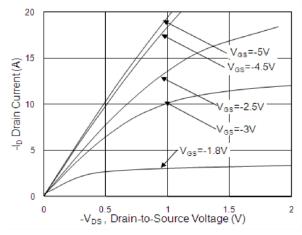
 $4_{\text{N}}$  The data is theoretically the same as I<sub>D</sub> and I<sub>DM</sub>, in real applications, should be limited by total power dissipation.

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#### **Typical Characteristics**



**Fig.1 Typical Output Characteristics** 

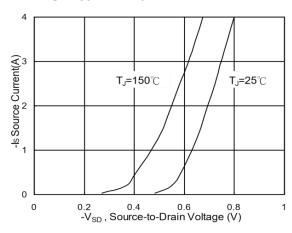
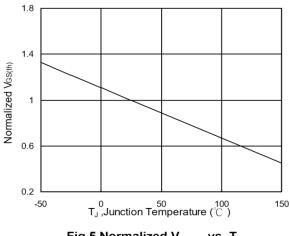
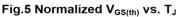


Fig.3 Forward Characteristics of Reverse





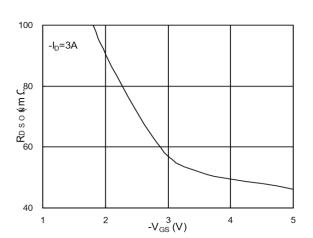
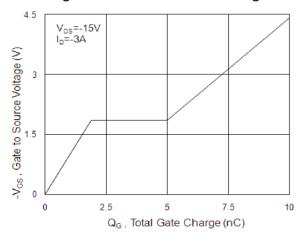


Fig.2 On-Resistance vs. G-S Voltage





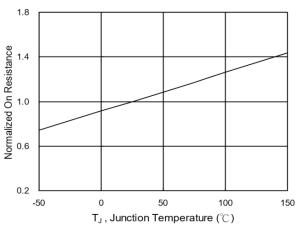


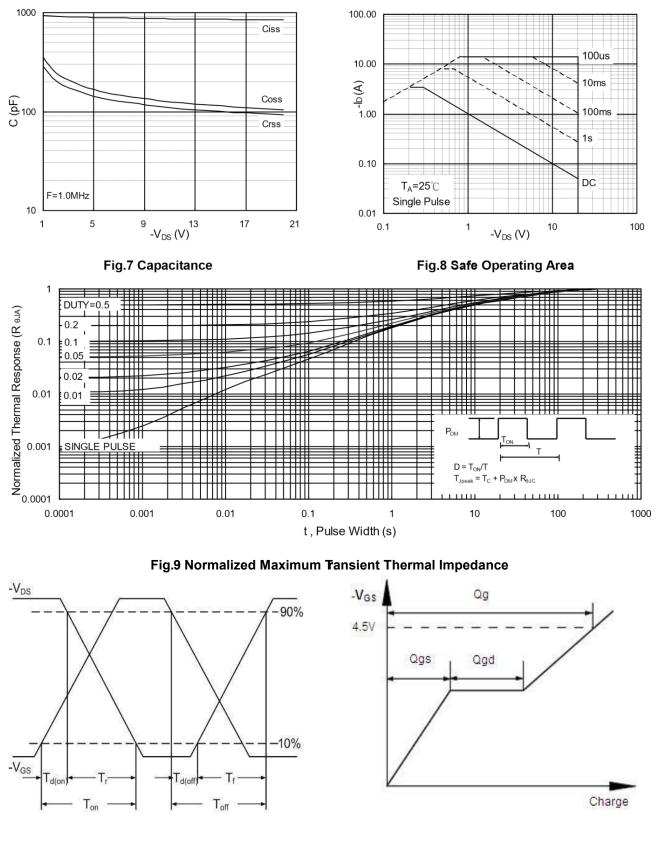
Fig.6 Normalized Roson vs. TJ

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#### Fig.10 Switching Time Waveform

### Fig.11 Gate Charge Waveform



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Edition	Date	Change
Rve1.0	2020/4/31	Initial release

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